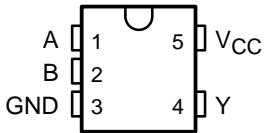
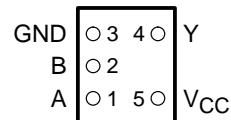


- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- Optimized for 1.8-V Operation and Is 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- I_{off} Supports Partial-Power-Down Mode Operation
- Sub 1-V Operable
- Max t_{pd} of 2.4 ns at 1.8 V
- Low Power Consumption, 10 μ A Max I_{CC}
- ± 8 -mA Output Drive at 1.8 V
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DBV OR DCK PACKAGE
(TOP VIEW)



YEA OR YZA PACKAGE
(BOTTOM VIEW)



description/ordering information

This single 2-input positive-AND gate is operational at 0.8-V to 2.7-V V_{CC} , but is designed specifically for 1.65-V to 1.95-V V_{CC} operation.

The SN74AUC1G08 performs the Boolean function $Y = A \bullet B$ or $Y = \overline{A} + \overline{B}$ in positive logic.

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
–40°C to 85°C	NanoStar™ WCSP (DSBGA) – YEA (Lead)	Tape and reel	SN74AUC1G08YEAR	____UE_
	NanoFree™ WCSP (DSBGA) – YZA (Lead-free)	Tape and reel	SN74AUC1G08YZAR	
	SOT (SOT-23) – DBV	Tape and reel	SN74AUC1G08DBVR	U08_
	SOT (SC-70) – DCK	Tape and reel	SN74AUC1G08DCKR	UE_

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

‡ DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

YEA/YZA: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site.



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SN74AUC1G08 SINGLE 2-INPUT POSITIVE-AND GATE

SCES374G – SEPTEMBER 2001 – REVISED SEPTEMBER 2002

FUNCTION TABLE

INPUTS		OUTPUT
A	B	Y
H	H	H
L	X	L
X	L	L

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	-0.5 V to 3.6 V
Input voltage range, V_I (see Note 1)	-0.5 V to 4.1 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	-0.5 V to 4.1 V
Output voltage range, V_O (see Note 1)	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	-50 mA
Output clamp current, I_{OK} ($V_O < 0$)	-50 mA
Continuous output current, I_O	±20 mA
Continuous current through V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 2):	
DBV package	206°C/W
DCK package	252°C/W
YEA/YZA package	154°C/W
Storage temperature range, T_{Stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
V_{CC}	Supply voltage		0.8	2.7	V
V_{IH}	High-level input voltage	$V_{CC} = 0.8 \text{ V to } 1.95 \text{ V}$	$0.65 \times V_{CC}$		V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		
V_{IL}	Low-level input voltage	$V_{CC} = 0.8 \text{ V to } 1.95 \text{ V}$		$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	
V_I	Input voltage		0	3.6	V
V_O	Output voltage		0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 0.8 \text{ V}$		-0.7	mA
		$V_{CC} = 1.1 \text{ V}$		-3	
		$V_{CC} = 1.4 \text{ V}$		-5	
		$V_{CC} = 1.65 \text{ V}$		-8	
		$V_{CC} = 2.3 \text{ V}$		-9	
I_{OL}	Low-level output current	$V_{CC} = 0.8 \text{ V}$		0.7	mA
		$V_{CC} = 1.1 \text{ V}$		3	
		$V_{CC} = 1.4 \text{ V}$		5	
		$V_{CC} = 1.65 \text{ V}$		8	
		$V_{CC} = 2.3 \text{ V}$		9	
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 0.8 \text{ V to } 1.95 \text{ V}$		20	ns/V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		10	
T_A	Operating free-air temperature		-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	MIN	TYP†	MAX	UNIT
V_{OH}	$I_{OH} = -100 \mu\text{A}$	$0.8 \text{ V to } 2.7 \text{ V}$	$V_{CC}-0.1$			V
	$I_{OH} = -0.7 \text{ mA}$	0.8 V		0.55		
	$I_{OH} = -3 \text{ mA}$	1.1 V		0.8		
	$I_{OH} = -5 \text{ mA}$	1.4 V		1		
	$I_{OH} = -8 \text{ mA}$	1.65 V		1.2		
	$I_{OH} = -9 \text{ mA}$	2.3 V		1.8		
V_{OL}	$I_{OL} = 100 \mu\text{A}$	$0.8 \text{ V to } 2.7 \text{ V}$		0.2		V
	$I_{OL} = 0.7 \text{ mA}$	0.8 V		0.25		
	$I_{OL} = 3 \text{ mA}$	1.1 V		0.3		
	$I_{OL} = 5 \text{ mA}$	1.4 V		0.4		
	$I_{OL} = 8 \text{ mA}$	1.65 V		0.45		
	$I_{OL} = 9 \text{ mA}$	2.3 V		0.6		
I_I	A or B input	$V_I = V_{CC} \text{ or } \text{GND}$	0 to 2.7 V		± 5	μA
I_{off}		$V_I \text{ or } V_O = 2.7 \text{ V}$	0		± 10	μA
I_{CC}		$V_I = V_{CC} \text{ or } \text{GND}$, $I_O = 0$	$0.8 \text{ V to } 2.7 \text{ V}$		10	μA
C_I		$V_I = V_{CC} \text{ or } \text{GND}$	2.5 V		3	pF

† All typical values are at $T_A = 25^\circ\text{C}$.

SN74AUC1G08

SINGLE 2-INPUT POSITIVE-AND GATE

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switching characteristics over recommended operating free-air temperature range, $C_L = 15 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 0.8 \text{ V}$	$V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$		$V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$			$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$			UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	TYP	MAX	MIN	MAX		
t_{pd}	A or B	Y	4.7	0.9	3.3	0.6	2.3	†	†	†	†	†	ns	

† This information was not available at the time of publication.

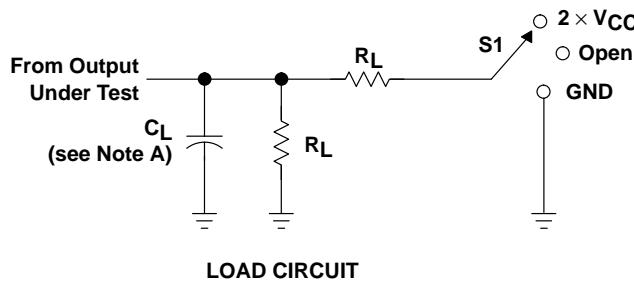
switching characteristics over recommended operating free-air temperature range, $C_L = 30 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$			$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$			UNIT
			MIN	TYP	MAX	MIN	MAX		
t_{pd}	A or B	Y	0.7	1.3	2.4	0.5	2	ns	

operating characteristics, $T_A = 25^\circ\text{C}$

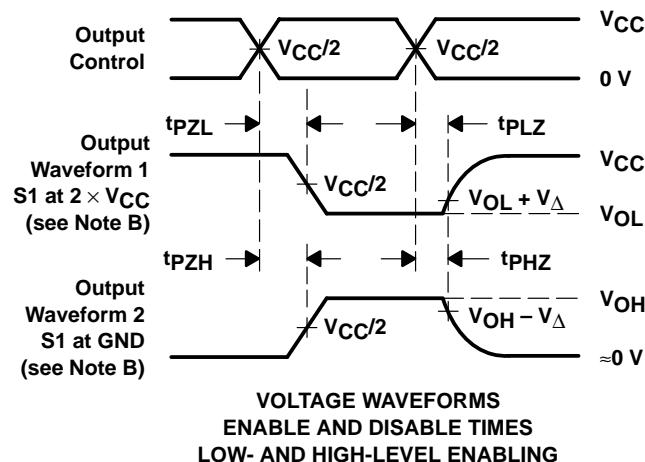
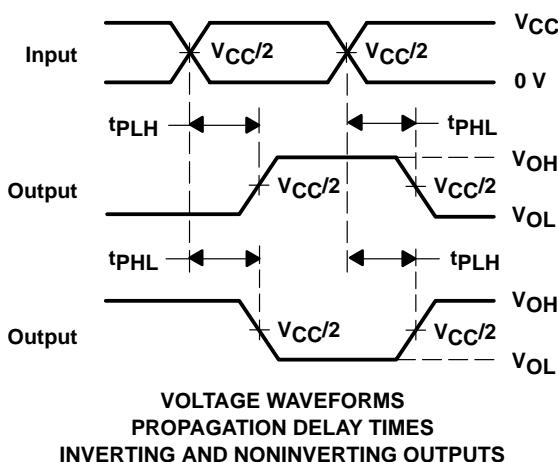
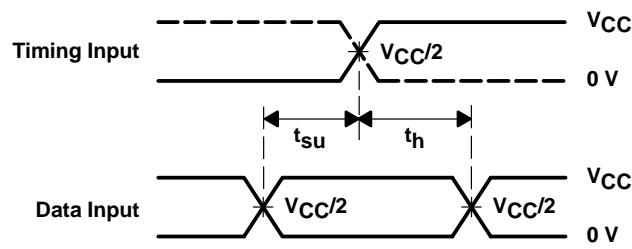
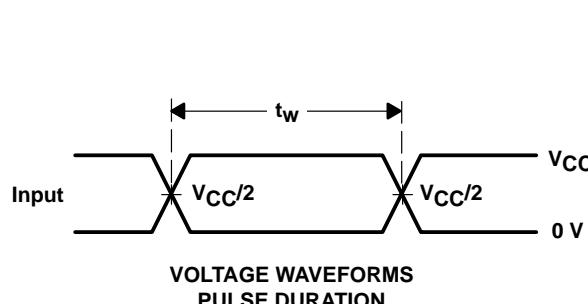
PARAMETER	TEST CONDITIONS	$V_{CC} = 0.8 \text{ V}$	$V_{CC} = 1.2 \text{ V}$	$V_{CC} = 1.5 \text{ V}$	$V_{CC} = 1.8 \text{ V}$	$V_{CC} = 2.5 \text{ V}$	UNIT
		TYP	TYP	TYP	TYP	TYP	
C_{pd}	Power dissipation capacitance $f = 10 \text{ MHz}$	15	15	15	15	19	pF

PARAMETER MEASUREMENT INFORMATION



TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND

V_{CC}	C_L	R_L	V_{Δ}
0.8 V	15 pF	2 k Ω	0.1 V
1.2 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.5 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.8 V \pm 0.15 V	15 pF	2 k Ω	0.15 V
2.5 V \pm 0.2 V	15 pF	2 k Ω	0.15 V
1.8 V \pm 0.15 V	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	30 pF	500 Ω	0.15 V



NOTES:

- C_L includes probe and jig capacitance.
- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, slew rate $\geq 1 V/ns$.
- The outputs are measured one at a time with one transition per measurement.
- t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- t_{PZL} and t_{PZH} are the same as t_{en} .
- t_{PLH} and t_{PHL} are the same as t_{pd} .
- All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265